MLSM MICROELECTRONICS

BSC160N15NS5ATMA1

150V/56A N-Channel MOSFET

Features

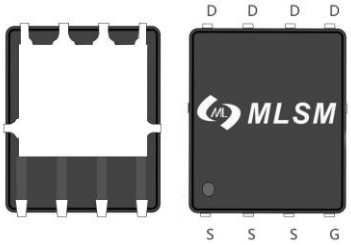
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

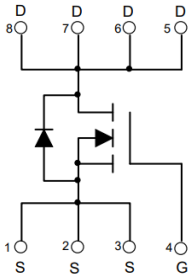
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

Product Summary

V_{DS}	$R_{DS(ON)}$ TYP	I_D
150V	13.7mΩ@10V	56A
	15.1mΩ@8V	



PDFN5X6-8L view



Schematic diagram

Pb-Free RoHS Halogen-Free

Absolute Maximum Ratings (TA=25℃unless otherwise noted)				
Symbol	**Parameter**		**Rating**	**Unit**
Common Ratings (TC=25°C Unless Otherwise Noted)				
V_{DS}	Drain-Source Breakdown Voltage		150	V
V_{GS}	Gate-Source Voltage		±20	V
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-55 to 150	°C
I_S	Diode Continuous Forward Current	Tc=25°C	66	A
Mounted on Large Heat Sink				
I_{DM}	Pulse Drain Current Tested	Tc=25°C	224	A
I_D	Continuous Drain Current	Tc=25°C	56	A
P_D	Maximum Power Dissipation	Tc=25°C	96	W
E_{AS}	Single pulse avalanche energy		43	Mj

Ordering Information (Example)					
Type	**Package**	**Minimum Package(pcs)**	**Inner Box Quantity(pcs)**	**Outer Carton Quantity(pcs)**	**Delivery Mode**
BSC160N15NS5ATMA1	PDFN5X6-8L	5,000	10,000	70,000	13"reel

Copyright©MLS Microelectronics Co., Ltd

Electrical Characteristics (TJ=25℃ unless otherwise noted)						
Symbol	**Parameter**	**Condition**	**Min**	**Typ**	**Max**	**Unit**
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$BV_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}=0V，I_D=1mA	150	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=120V，V_{GS}=0V	--	--	1	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±20V，V_{DS}=0V	--	--	±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}，I_D=60μA	3	3.8	4.6	V
$R_{DS(on)}$	Drain-Source On-State Resistance	V_{GS}=10V，I_D=28A	--	13.7	16	mΩ
		V_{GS}=8V，I_D=14A	--	15.1	18.5	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C_{ISS}	Input Capacitance	V_{DS}=75V，V_{GS}=0V， f=1MHz	--	1370	--	pF
C_{OSS}	Output Capacitance		--	341	--	pF
C_{RSS}	Reverse Transfer Capacitance		--	9.6	--	pF
Switching Characteristics						
Q_g	Total Gate Charge	V_{DD}=75V，I_D=28A，V_{GS}=10V	--	19	--	nC
Q_{gs}	Gate Source Charge		--	8	--	nC
Q_{gd}	Gate Drain Charge		--	4	--	nC
$t_{d(on)}$	Turn-on Delay Time	V_{DD}=75V，I_D=28A，V_{GS}=10V，R_G=3Ω	--	9.6	--	nS
t_r	Turn-on Rise Time		--	3	--	nS
$t_{d(off)}$	Turn-Off Delay Time		--	10.8	--	nS
t_f	Turn-Off Fall Time		--	2.6	--	nS
Source- Drain Diode Characteristics						
V_{SD}	Forward on voltage	Tj=25°C，Is=28A	--	0.88	1.2	V

Copyright©MLS Microelectronics Co., Ltd

Typical Operating Characteristics

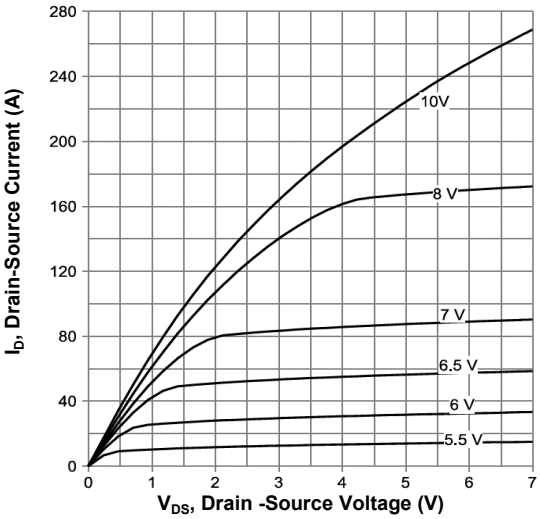


Fig1. Typical Output Characteristics

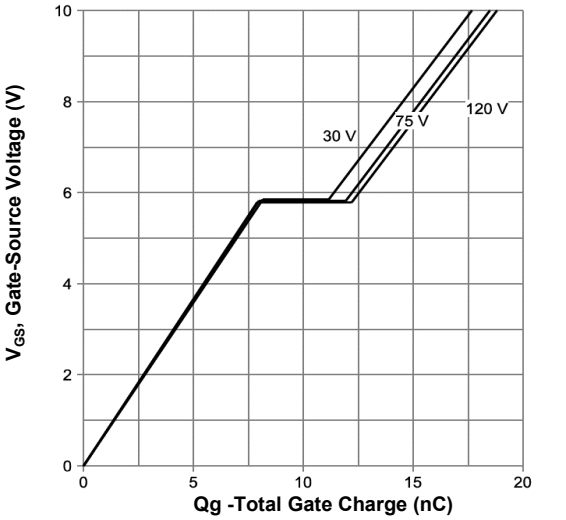


Fig2. Typical Gate Charge Vs.Gate-Source Voltage

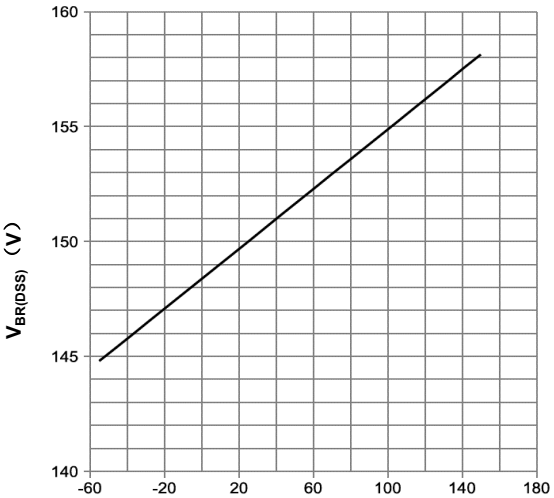


Fig3. Drain-sourcebreakdownvoltage

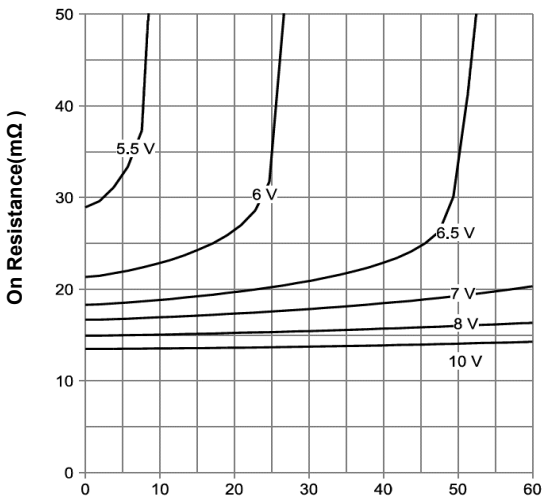


Fig4. On-Resistance Vs. Drain-Source Current

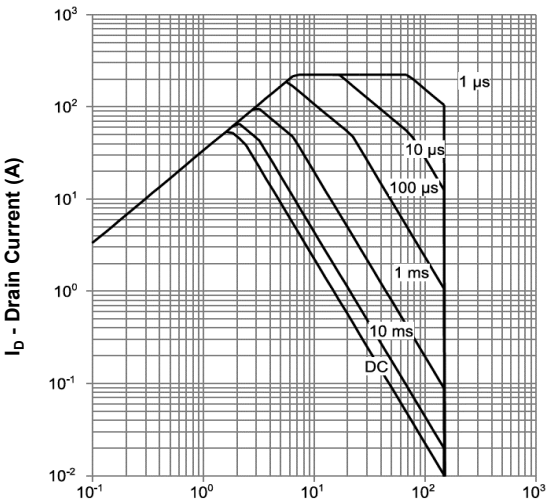


Fig5. Maximum Safe Operating Area

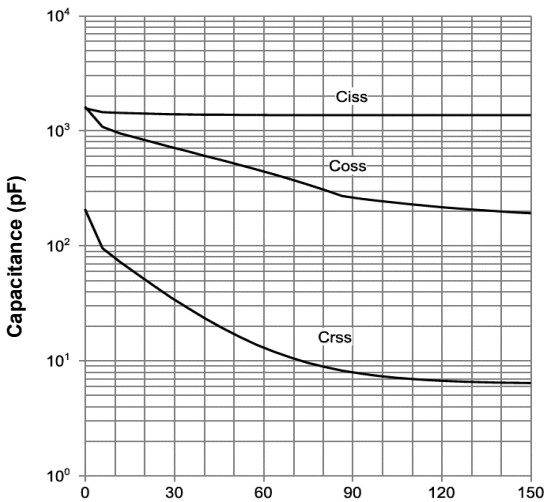
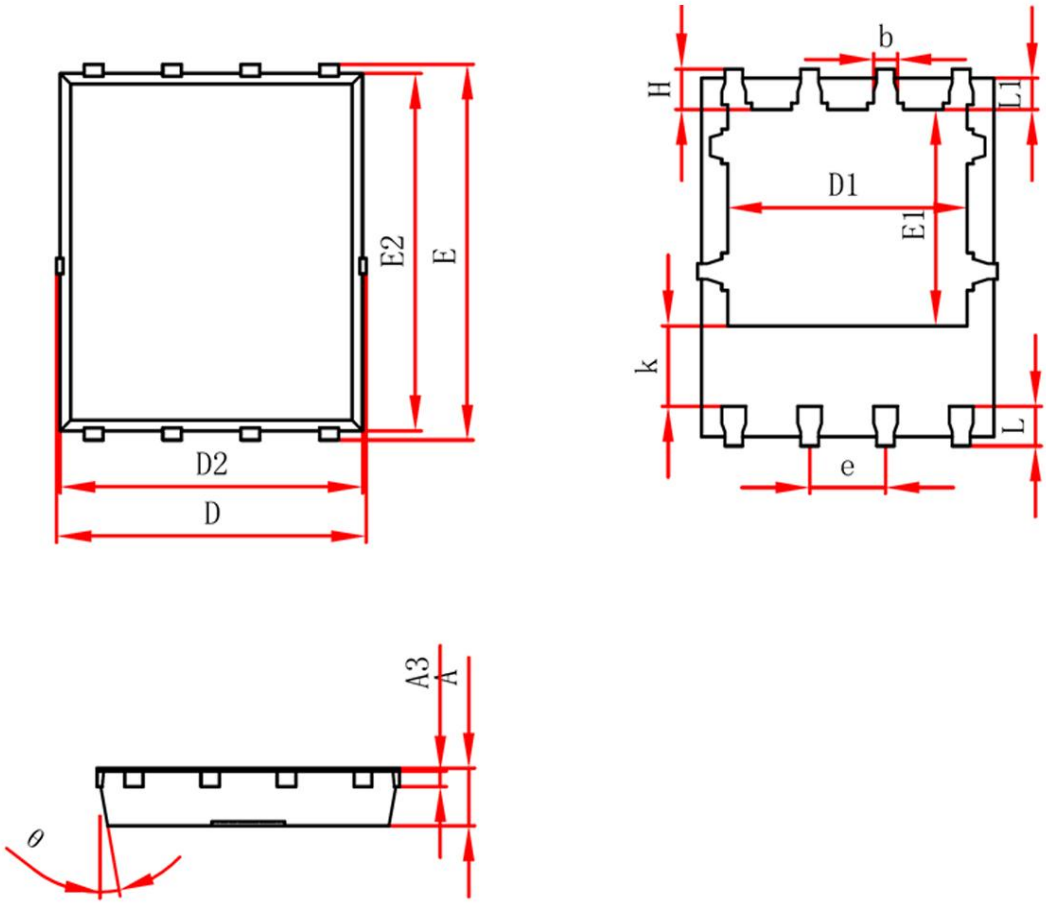


Fig6 Typical Capacitance Vs.Drain-Source

Copyright©MLS Microelectronics Co., Ltd

PDFN5X6-8L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.950	1.050	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.950	5.050	0.196	0.200
E	5.950	6.050	0.235	0.239
D1	4.026	4.126	0.159	0.163
E1	3.510	3.610	0.139	0.143
D2	4.850	4.950	0.192	0.196
E2	5.700	5.800	0.225	0.229
k	1.190	1.390	0.047	0.055
b	0.300	0.400	0.012	0.016
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°

Copyright©MLS Microelectronics Co., Ltd